錫線---免水洗型---SE

勝 特 力 材 料 886-3-5753170 胜特力电子(上海) 86-21-54151736 胜特力电子(深圳) 86-755-83298787 Http://www.100y.com.tw

06003RMA/SE-26006RMA/SE-26008RMA/SE-26010RMA

規格說明:

RMA Series

MODEL	Description	M.P. /°C	Dia./ømm	Sn / %	Weight/g
SE-06003RMA	RMA solder	183	0.3	60	100
SE-26006RMA	RMA solder	183	0.6	60	200
SE-26008RMA	RMA solder	183	0.8	60	200
SE-26010RMA	RMA solder	183	1.0	60	200

Special Spool Solder SF/ RMA/ PL series



WWW.100Y.COM.TW Solder for Every Job SF/RMA/PL series

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Product Specifications

PRODUCT SPECIFICATIONS

SE-2AG08, 2CU08 and 26308 are rosin core. SE-2ST16 and 2BA16 are not rosin core. SE-2ST16 requires flux for stainless steel, and SE-2BA16 requires flux for metal work.

	WWW.100Y.CO	OM.TW	MW.	OOY.CO	MTW
MODEL	Description	M.T.	Dia.	Sn	Weight
SE-2AG08	Ag solder	178-211°C	arphi 0.8mm	60%	COM.TW
SE-2AG12	Ag solder	178-211°C	φ 1.2mm	60%	$CO^{M.T}$
SE-2CU08	Cu solder	182-257°C	arphi 0.8mm	60%	2009
SE-26308	Eutectic solder	183-184°C	arphi 0.8mm	63%	2 00g
SE-2ST16	Stainless use solder	183-184°C	φ 1.6mm	63%	1100 X C
SE-2BA16	Metal work use solder	183-227°C	arphi 1.6mm	45%	W.100X.

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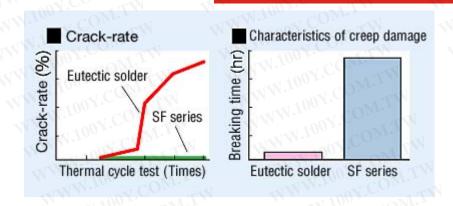
LEAD-FREE SOLDER

'Anti-cracking properties' stop cracking caused by repeated heating and cooling of electronic components. Although lead-free solder has a higher melting point than eutectic solder, the crack occurrence rate is low, the "rate of creep" is slower and wettability is better, making more reliable solder joints.



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Type of Solder	M.T.	Wetting TIme
SF SERIES (lead-free)	217-220°C	1.8 sec.
goot Eutectic solder(SD-45)	183-184°C	0.8 sec.
Sn-2.8Ag-1.0Bi-0.5Cu	214-215°C	1.33 sec.

IMPORTANT NOTICE

The SF seris is subject to certain U.S. patent restrictions and therefore, shall not be sold or used in manufacturing or repairs in the U.S.

If it is, TAIYO ELECTRIC IND.CO.,LTD. will not be responsible for any patent

infringement.

JP. PAT. No. 3027441

U.S. PAT. No. 5527628

MODEL	M.T.	Dia.	Composition	Weight
SF-A0403	OX.COM.TW	φ 0.3mm	OOX.COM.TW	WWW
SF-A0404	OOY.COM.TW	arphi 0.4mm	100X.COM.TW	WIN
SF-A0406	217-220°C	\sqrt{arphi} φ 0.6mm $^{ ext{N}}$	Sn,Ag,Cu 96.5-3.0-0.5	45g
SF-A0408	N.100Y.COM	arphi 0.8mm	VV-100V-COM	IM I
SF-A0410	M.100X.CON	φ 1.0mm	MM.1700A'COM	LTW

RMA WASH FREE SOLDER (ROSIN CORE)

The SOLPET RMA series is high capacity solder containing rosin and developed to be wash free. Improved reliability even under the severest high temperature and humid conditions. It sets a new standard of reliability.

FEATURES

 Solder with rosin that does not contain halide makes the copper surface active, which allows wash free soldering of PCBs. Minimal residual contamination improves

特力材料886-3-5753170 胜特力电子(上海) 86-21-54151736 胜特力电子(深圳) 86-755-83298787 Http://www.100y.com.tw



the reliability of products such as computers, telephones and stereos.

MODEL	ITEM	M.P.	Dia.	Sn	Weight
SE-06003RMA	Y.COM.TW	MMM.100	φ 0.3mm	N	100g
SE-26006RMA	RMA wash free	192 10000	arphi 0.6mm	600/	WWW
SE-26008RMA	solder	183-190°C	φ 0.8mm	60%	200g
SE-26010RMA		WW	arphi 1.0mm		WY

POWER SOLDER (ROSIN CORE)

Recently, manufacturers require
more durable soldering. With its
excellent 'anti-crack' strength and
efficient soldering, Power Solder is
the answer to cracking caused by
heat cycle stress of electronic
components.

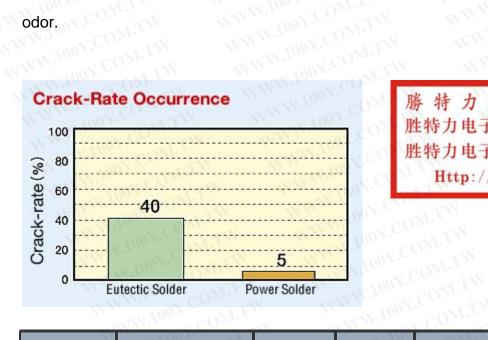
FEATURES

•Compared with Eutectic solder, the rate of solder crack during thermal cycle tests is less than 1/8. Contains a mixture of high performance activator for excellent wetting.•The highest quality materials are used to minimize

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MODEL	Item	M.P.	Dia.	Sn	Weight
SE-26206PL	MMM.100X.CO	LTW	arphi 0.6mm	OX.COM.T	N
SE-26208PL	DOWED COLDED	470 40000	arphi 0.8mm		200~
SE-26210PL	POWER SOLDER	179-189°C	arphi 1.0mm	undisclosed	200g
SE-26212PL	WWW.100Y	COMITW	φ 1.2mm	NN.100X.CO	